Based on the successful Student Sessions of the previous years, the International Solid-State Circuits Conference (ISSCC) will continue the student activity at ISSCC 2015. One of the goals of the ISSCC Student Research Preview is to encourage student participation and networking at ISSCC. In particular, it will provide graduate students (Masters and PhD candidates) with:

- A great opportunity to showcase the directions of their work
- An opportunity to experience ISSCC quality
- An opportunity to interact with others in the ISSCC community
- Encouragement for future regular-paper submissions

More particularly, it will provide graduate students with:

- An opportunity for mutual understanding of academic research styles and cultures
- An opportunity to exchange experiences
- An opportunity to improve communication skills

The ISSCC Student Research Preview is organized as short presentations of work-in-progress in conjunction with a poster presentation and optional demo. The presentations and posters will NOT be considered as prepublication in future ISSCC or other SSCS sponsored conference or journal submissions. However, presenters should not post the work or the title of their presentation on their website (this will be considered prepublication). The focus of the SRP presentation should be on student's novel ideas not published elsewhere and can describe research-in-progress. Multiple authors are allowed, but the presentation should focus on research from a single student.

Results with actual silicon implementation are highly encouraged, although not required. Papers that have been accepted as a regular presentation at ISSCC or that overlap substantially with an accepted ISSCC paper will not be considered for the Student Research Preview session. However, papers that significantly extend a prior ISSCC publication by the student will be considered.

An endorsement from the advisor is required by the submission deadline. Each faculty member can recommend only one student from his or her group. The students should consult with their advisor prior to submitting slides to inform the advisor of this one-submission rule per group and the need to submit an endorsement.

The ISSCC student registration fee will be waived for the presenter of an accepted presentation. Speakers will be contacted about how to claim the free Conference student registration. In addition, SRP presenters can apply for a competitive travel grant through the Solid-State Circuits Society's Student Travel Grant program. A prize for the Best Poster Presentation will be awarded. Please, note that students who have their presentation accepted should apply for a visa as soon as they have received notice of acceptance. Letters of invitation can be received by contacting Melissa Widerkehr: MelissaW@widerkehr.com.

Submission of the Slides
A short PowerPoint presentation must be submitted using a Powerpoint visuals template that is available from the following website (http://www.epapers.org/isscc2015). If you are interested in giving a demo during the poster session, please indicate so on the last slide of the submission. In addition, the advisor of the student must send an endorsement to the SRP Secretary, Prof. SeongHwan Cho at chosta@kaist.ac.kr. The PowerPoint file consists of the following:
• One slide with basic information about the submission (see Template).
• One slide that lists the research area, title of research, student’s name, department, university, contact information, awarded degrees, degree now being pursued, advisor’s name, position, and contact information.
• One slide of less than 150-word abstract.
• 5-7 slides of research overview and research details. References must be made to others’ earlier work, preferably that published in ISSCC, JSSC, or other IEEE publications.
• For those who are interested in giving a demo, fill out the last slide of the submission template.

An acknowledgement will be sent to the authors when the file is received. The author should contact Prof. SeongHwan Cho if he or she does not receive an acknowledgment by email within a couple of days of submission. A template PowerPoint file can be downloaded from http://www.epapers.org/isscc2015. Prospective speaker must be a student at the time of the conference.

Submission of Final Presentation and Poster
Accepted speakers will be asked to submit the final PowerPoint presentation slides and poster. Information about the format of the slides and poster will be available on the ISSCC website.

Important Dates
October 22, 2014: Abstract and slide submission deadline
November 7, 2014: Acceptance Notification
February 12, 2015: Submission deadline of final presentation
February 22, 2015: Student Research Preview Presentations (7:30-10pm)

Further Information
Visit the ISSCC Student Research Preview website http://www.isscc.org/ for further details. Or contact the Chair, Professor Jan Van der Spiegel at e-mail: jan@seas.upenn.edu, Tel: +1-215-898-7116, or the Co-Chair, Professor SeongHwan Cho at e-mail chosta@kaist.ac.kr, Tel: +82-42-350-3480.

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